

NCE N-Channel Enhancement Mode Power MOSFET

Description

The NCE3080L uses advanced trench technology and design to provide excellent $R_{DS(ON)}$ with low gate charge. It can be used in a wide variety of applications.

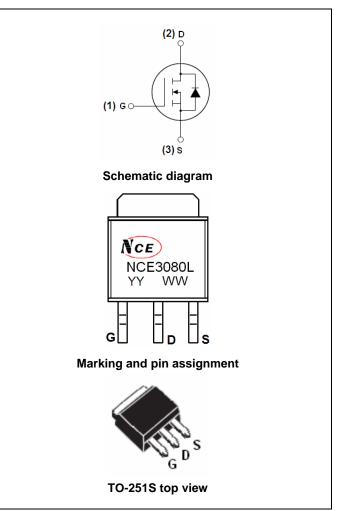
General Features

- V_{DS} =30V,I_D =80A
 R_{DS(ON)} <6.5mΩ @ V_{GS}=10V
 R_{DS(ON)} < 10mΩ @ V_{GS}=5V
- High density cell design for ultra low Rdson
- Fully characterized avalanche voltage and current
- Good stability and uniformity with high E_{AS}
- Excellent package for good heat dissipation

Application

- Power switching application
- Hard switched and high frequency circuits
- Uninterruptible power supply

100% UIS TESTED!



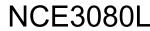
Package Marking and Ordering Information

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
NCE3080L	NCE3080L	TO-251S	-	-	-

Absolute Maximum Ratings (T_c=25[°]C unless otherwise noted)

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	Vds	30	V
Gate-Source Voltage	V _{GS}	±20	V
Drain Current-Continuous	ID	80	А
Drain Current-Continuous(T _C =100℃)	I _D (100℃)	50	А
Pulsed Drain Current	I _{DM}	170	А
Maximum Power Dissipation	PD	83	W
Derating factor		0.56	W/℃
Single pulse avalanche energy (Note 5)	E _{AS}	150	mJ
Operating Junction and Storage Temperature Range	T _J ,T _{STG}	-55 To 175	°C





Thermal Characteristic

Thermal Resistance, Junction-to-Case ^(Note 2) R _{0JC} 1.8 °C/W
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Electrical Characteristics (T_C=25[°]C unless otherwise noted)

Parameter	Symbol	Condition	Min	Тур	Max	Unit	
Off Characteristics		·					
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V I _D =250µA	30	-	-	V	
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =30V,V _{GS} =0V	-	-	1	μA	
Gate-Body Leakage Current	I _{GSS}	V _{GS} =±20V,V _{DS} =0V	-	-	±100	nA	
On Characteristics (Note 3)		·					
Gate Threshold Voltage	$V_{GS(th)}$	V _{DS} =V _{GS} ,I _D =250µA	1	1.6	3	V	
Drain-Source On-State Resistance	R _{DS(ON)}	V _{GS} =10V, I _D =30A	-	5.5	6.5	– mΩ	
Diam-Source On-State Resistance		V _{GS} =5V, I _D =24A	-	7.5	10		
Forward Transconductance	g fs	V _{DS} =5V,I _D =24A	20	-	-	S	
Dynamic Characteristics (Note4)		·					
Input Capacitance	C _{lss}		-	2330	-	PF	
Output Capacitance	C _{oss}	V _{DS} =15V,V _{GS} =0V, F=1.0MHz	-	460	-	PF	
Reverse Transfer Capacitance	C _{rss}		-	230	-	PF	
Switching Characteristics (Note 4)							
Turn-on Delay Time	t _{d(on)}		-	20	-	nS	
Turn-on Rise Time	tr	V _{DD} =10V,I _D =30A	-	15	-	nS	
Turn-Off Delay Time	t _{d(off)}	V_{GS} =10V, R_{GEN} =2.7 Ω	-	60	-	nS	
Turn-Off Fall Time	t _f		-	10	-	nS	
Total Gate Charge	Qg	V -40V/L -20A	-	51	-	nC	
Gate-Source Charge	Q _{gs}	V _{DS} =10V,I _D =30A, V _{GS} =10V	-	14	-	nC	
Gate-Drain Charge	Q _{gd}	V _{GS} =10V	-	11	-	nC	
Drain-Source Diode Characteristics							
Diode Forward Voltage (Note 3)	V _{SD}	V _{GS} =0V,I _S =24A	-	-	1.2	V	
Diode Forward Current (Note 2)	Is		-	-	80	А	
Reverse Recovery Time	trr	TJ = 25°C, IF = 80A	-	32	50	nS	
Reverse Recovery Charge	Qrr	di/dt = 100A/µs(Note3)	-	12	20	nC	
Forward Turn-On Time	t _{on}	Intrinsic turn-on time is negligible (turn-on is dominated by LS+LD)					

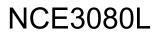
Notes:

- **1.** Repetitive Rating: Pulse width limited by maximum junction temperature.
- **2.** Surface Mounted on FR4 Board, $t \le 10$ sec.
- **3.** Pulse Test: Pulse Width \leq 300µs, Duty Cycle \leq 2%.
- 4. Guaranteed by design, not subject to production
- 5. EAS condition: Tj=25 $^\circ\! \mathbb{C}$,V_DD=15V,V_G=10V,L=1mH,Rg=25\Omega



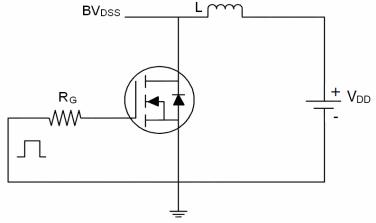
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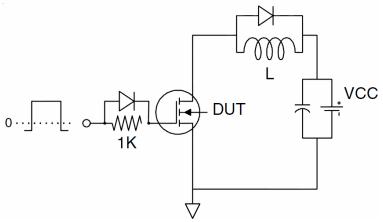


Test Circuit

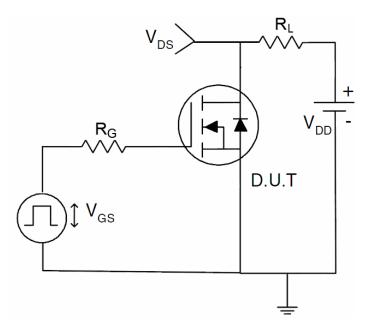
1) E_{AS} Test Circuits



2) Gate Charge Test Circuit

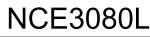


3) Switch Time Test Circuit:

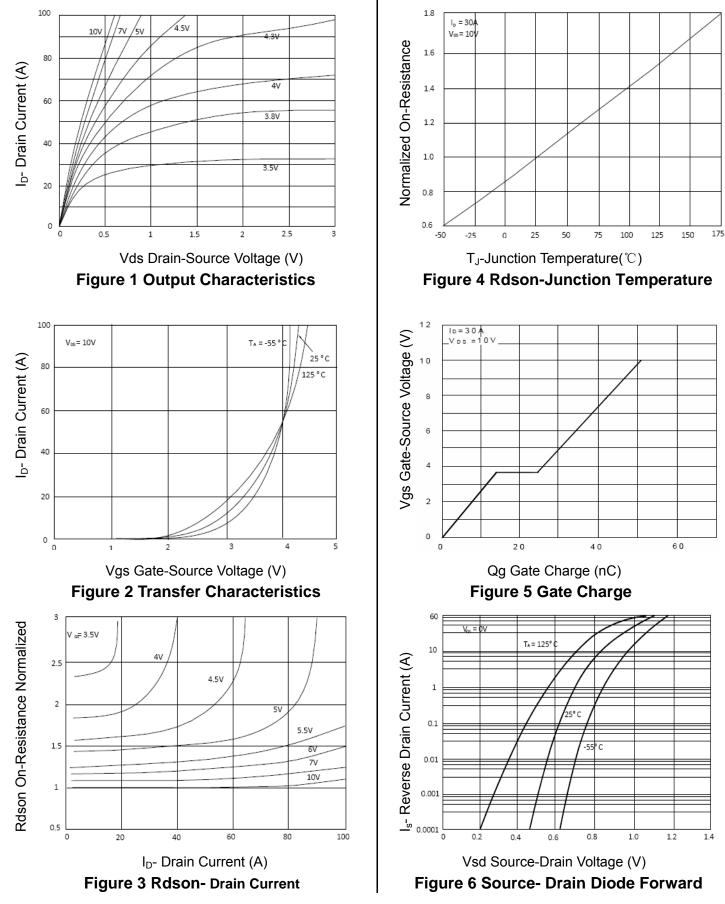








Typical Electrical and Thermal Characteristics (Curves)





C Capacitance (pF)

300 200

100

50 20

10

5

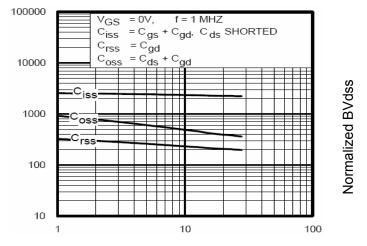
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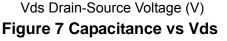
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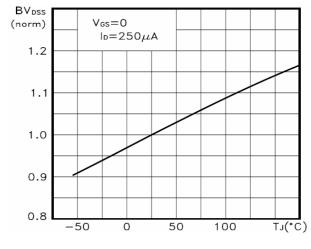
0.5

I_D- Drain Current (A)

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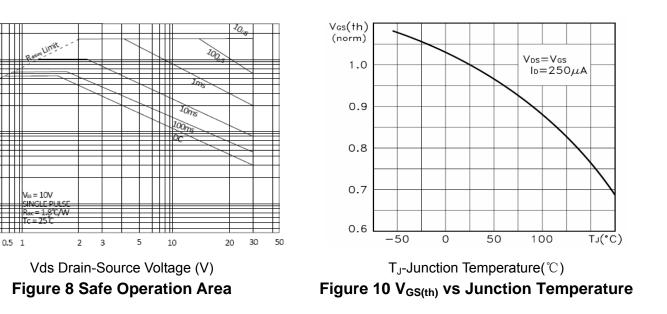


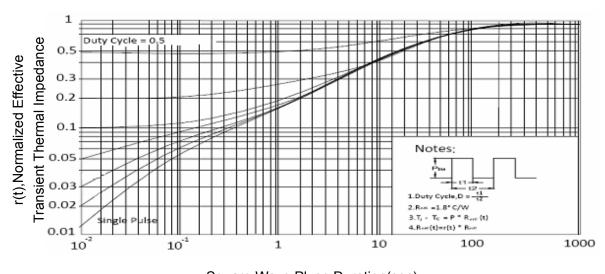


Pb Free Product

NCE3080L





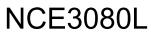


Square Wave Pluse Duration(sec) Figure 11 Normalized Maximum Transient Thermal Impedance

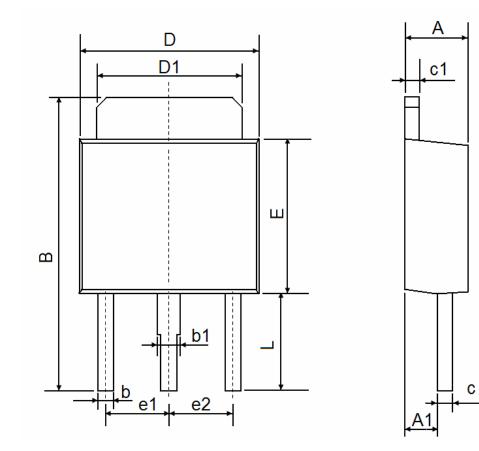


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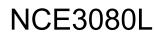
TO-251S Package Information



Symbol	Dimensions In Millimeters		Dimensions In Inches		
	Min.	Max.	Min.	Max.	
A	2.250	2.350	0.089	0.093	
A1	1.150	1.250	0.045	0.049	
В	10.200	10.800	0.402	0.425	
b	0.550	0.650	0.022	0.026	
b1	0.750	0.850	0.030	0.033	
С	0.480	0.540	0.019	0.021	
c1	0.480	0.540	0.019	0.021	
D	6.400	6.600	0.252	0.260	
D1	5.250	5.350	0.207	0.211	
E	5.400	5.600	0.213	0.220	
e1	2.300 TYP		0.091 TYP		
e2	2.300 TYP		0.091 TYP		
L	3.300	3.700	0.130	0.146	







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